

# T-1 (3mm) BI-LEVEL LED INDICATOR

Part Number: WP7104ALUP/2YD-0L Yellow

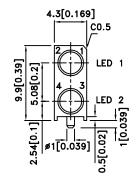
#### **Features**

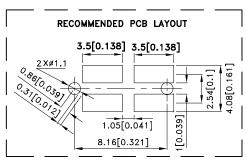
- Black case enhances contrast ratio.
- Wide viewing angle.
- High reliability life measured in years.
- Moisture sensitivity level : level 3.
- Housing material: PPA.
- Housing UL rating: 94V-0.
- High temperature resistant housing.
- High glass transition temperature epoxy.
- RoHS compliant.

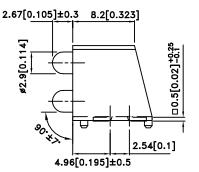
## **Description**

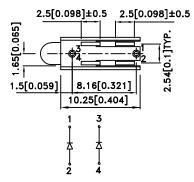
The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.

## **Package Dimensions**









#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

SPEC NO: DSAH3816 REV NO: V.9B DATE: SEP/16/2016 PAGE: 1 OF 6
APPROVED: Wynec CHECKED: Allen Liu DRAWN: L.T.Zhang ERP: 1102013041



### **Selection Guide**

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 10mA		Viewing Angle [1]
		,	Min.	Тур.	201/2
WP7104ALUP/2YD-0L	Yellow (GaAsP/GaP)	Yellow Diffused	8	15	50°

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.
- 3. Luminous intensity value is traceable to CIE127-2007 standards.

# Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Yellow	590		nm	IF=10mA
λD [1]	Dominant Wavelength	Yellow	588		nm	IF=10mA
Δλ1/2	Spectral Line Half-width	Yellow	35		nm	IF=10mA
С	Capacitance	Yellow	20		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Yellow	1.95	2.5	V	IF=10mA
IR	Reverse Current	Yellow		10	uA	V <sub>R</sub> =5V

- Wavelength: +/-1nm.
   Forward Voltage: +/-0.1V.
   Wavelength value is traceable to CIE127-2007 standards.
- 4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

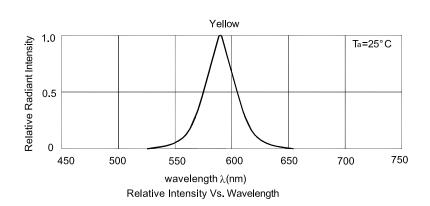
### Absolute Maximum Ratings at TA=25°C

Parameter	Values	Units		
Power dissipation	75	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	140	mA		
Reverse Voltage	5	V		
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

#### Notes:

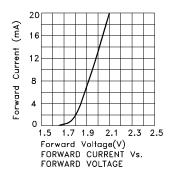
- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

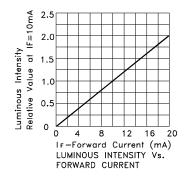
PAGE: 2 OF 6 SPEC NO: DSAH3816 **REV NO: V.9B** DATE: SEP/16/2016 APPROVED: Wynec **CHECKED: Allen Liu** DRAWN: L.T.Zhang ERP: 1102013041

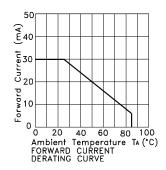


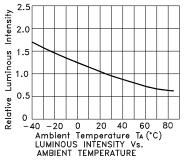
#### Yellow

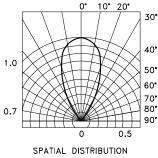
#### WP7104ALUP/2YD-0L







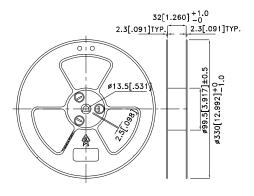




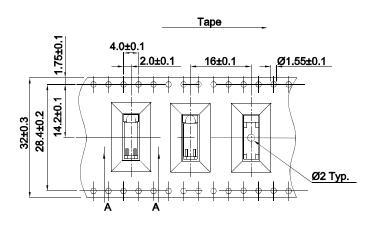
SPEC NO: DSAH3816 APPROVED: Wynec REV NO: V.9B CHECKED: Allen Liu DATE: SEP/16/2016 DRAWN: L.T.Zhang PAGE: 3 OF 6 ERP: 1102013041

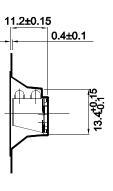
### WP7104ALUP/2YD-0L

### **Reel Dimension**



# Tape Dimensions (Units: mm)





PAGE: 4 OF 6

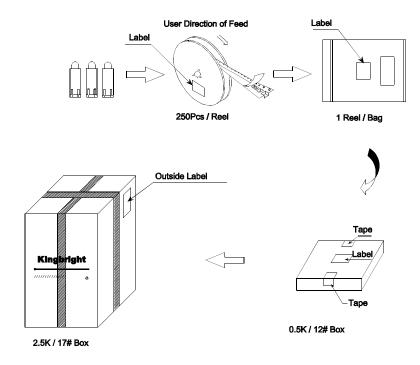
ERP: 1102013041



SPEC NO: DSAH3816 REV NO: V.9B DATE: SEP/16/2016
APPROVED: Wynec CHECKED: Allen Liu DRAWN: L.T.Zhang

#### **PACKING & LABEL SPECIFICATIONS**

#### WP7104ALUP/2YD-0L





### Terms and conditions for the usage of this document

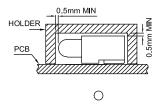
- 1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- 2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- 3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
- 4. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
- 5. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
- 6. All design applications should refer to Kingbright application notes available at http://www.KingbrightUSA.com/ApplicationNotes

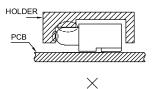
SPEC NO: DSAH3816 REV NO: V.9B DATE: SEP/16/2016 PAGE: 5 OF 6

APPROVED: Wynec CHECKED: Allen Liu DRAWN: L.T.Zhang ERP: 1102013041

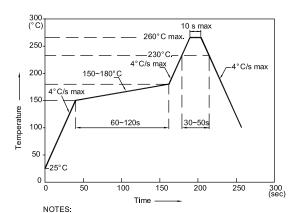
#### **PRECAUTIONS**

- 1.A moisture barrier bag (MBB) containing LEDs shall be kept in an environment with temperature below 40°C and humidity below 90% RH.
- A MBB shall be kept sealed until the LEDs contained in that bag are to be used immediately. Storge in an environment with temperature 5~30°C and humidity below 60% RH.
- 2.After a MBB has been opened, all LEDs contained in that bag shall complete soldering process within according to the conditions listed on the Kingbright MBB.
- 3.If the 10% spot of a humidity indicator card (HIC) indicates wet, LEDs shall be baked according to the conditions listed on the Kingbright MBB.
- 4.During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.





- 5. The tip of the soldering iron should never touch the lens epoxy.
- 6.After soldering, allow at least three minutes for the component to cool down to room temperature before further operations.
- 7.If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
- 8.Recommended Reflow Soldering Profiles For SMD Housing LEDs



- 1.We recommend the reflow temperature 245°C(±5°C).The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature
- to high temperature.

  3.Recommended Solder: Sn/Cu/Ag.
- 4.No more than once

SPEC NO: DSAH3816 REV NO: V.9B DATE: SEP/16/2016 PAGE: 6 OF 6
APPROVED: Wynec CHECKED: Allen Liu DRAWN: L.T.Zhang ERP: 1102013041